PCN # 2266 DATE: March 31, 2022

EXPECTED PCN SHIP DATE: March 31, 2022



Quality Assurance 160 Rio Robles San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE X PRODUCT CHANGE NOTICE

ANALOG DEVICES HEREBY ISSUES NOTIFICATION OF CHANGE THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN	X WAFER FAB	ASSEMBL	Y	TEST	ELEC/MECH SPECS
AFFECTED PRODUCT:					
Ordering P/N: (See PN listing XLS in PCN ZIP file)					
CHANGE FROM: -		CHANGE TO: -			
For MAX17502F/M	AX17502G (Step-Down DC-	DC Converter			
ICs)					
Existing source for wafer fabrication at Epson/Sakata/Japan using			Expanding waferfab supply source to Powerchip/Taiwan		
S18 process technology			(Fab101) using same S18 process technology		
JUSTIFICATION: -					
Adding Fab101 to expand wafer capacity and ensure supply continuity.					
Fab101 fab site has been qualified and shipping other products in high volume using S18 process technology since 2010.					
Fab101 S18 process successfully passed Maxim qualification requirements (see attachment ref. FAB101_S18U).					
The Form/Fit/Function of these devices remain unchanged.					
TRACEABILITY: Analog Device maintains full traceability by device marking, packaging labels and shipment documents.					

Analog Devices's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

Nasser Ali Chaouche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Analog Devices Company Representative or

Nasser AliChaouche, PCN Coordinator 408-601-5660 / pcn.coordinator@maximintegrated.com